### SN54ACT563, SN74ACT563 OCTAL D-TYPE TRANSPARENT LATCHES WITH 3-STATE OUTPUTS

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- 4.5-V to 5.5-V V<sub>CC</sub> Operation
- Inputs Accept Voltages to 5.5 V
- Max t<sub>pd</sub> of 8.5 ns at 5 V
- Inputs Are TTL-Voltage Compatible
- 3-State Inverted Outputs Drive Bus Lines Directly
- Flow-Through Architecture to Optimize PCB Layout

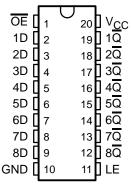
#### description/ordering information

The 'ACT563 devices are octal D-type transparent latches with 3-state outputs. When the latch-enable (LE) input is high, the  $\overline{Q}$  outputs are set to the complements of the data (D) inputs. When LE is taken low, the  $\overline{Q}$  outputs are latched at the inverse logic levels set up at the D inputs.

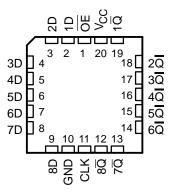
A buffered output-enable ( $\overline{OE}$ ) input places the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased high logic level provide the capability to drive bus lines without interface or pullup components.

OE does not affect internal operations of the latches. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

SN54ACT563 . . . J OR W PACKAGE SN74ACT563 . . . DB, DW, N, NS, OR PW PACKAGE (TOP VIEW)



SN54ACT563...FK PACKAGE (TOP VIEW)



To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

#### ORDERING INFORMATION

| TA             | PACKAGI    | ΕŢ            | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>MARKING |  |
|----------------|------------|---------------|--------------------------|---------------------|--|
|                | PDIP – N   | Tube          | SN74ACT563N              | SN74ACT563N         |  |
| –40°C to 85°C  | SOIC - DW  | Tube          | SN74ACT563DW             | ACT563              |  |
|                | 30IC - DW  | Tape and reel | SN74ACT563DWR            | AC1565              |  |
| -40 C to 65 C  | SOP - NS   | Tape and reel | SN74ACT563NSR            | ACT563              |  |
|                | SSOP – DB  | Tape and reel | SN74ACT563DBR            | AD563               |  |
|                | TSSOP – PW | Tape and reel | SN74ACT563PWR            | AD563               |  |
|                | CDIP – J   | Tube          | SNJ54ACT5634J            | SNJ54ACT563J        |  |
| –55°C to 125°C | CFP – W    | Tube          | SNJ54ACT563W             | SNJ54ACT563W        |  |
|                | LCCC – FK  | Tube          | SNJ54ACT563FK            | SNJ54ACT563FK       |  |

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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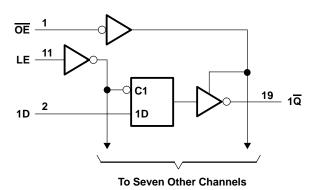


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## FUNCTION TABLE (each latch)

|    | INPUTS | OUTPUT |                  |
|----|--------|--------|------------------|
| OE | LE     | D      | Q                |
| L  | Н      | Н      | L                |
| L  | Н      | L      | н                |
| L  | L      | Χ      | $\overline{Q}_0$ |
| Н  | Х      | Χ      | Z                |

### logic diagram (positive logic)



### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V <sub>CC</sub>                          |               | –0.5 V to 7 V  |
|--|---------------|----------------|
| Input voltage range, V <sub>I</sub> (see Note 1)               |               |                |
| Output voltage range, VO (see Note 1)                          |               |                |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ). |               |                |
| Output clamp current, IOK (VO < 0 or VO > VC                   | C)            | ±20 mA         |
| Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )     |               | ±50 mA         |
| Continuous current through V <sub>CC</sub> or GND              |               | ±200 mA        |
| Package thermal impedance, θ <sub>JA</sub> (see Note 2)        | ): DB package | 70°C/W         |
| •••  | DW package    | 58°C/W         |
|  | N package     | 69°C/W         |
|  | NS package    | 60°C/W         |
|  | PW package    | 83°C/W         |
| Storage temperature range, T <sub>sto</sub>                    |               | –65°C to 150°C |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.



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#### recommended operating conditions (see Note 3)

|                 |                                    | SN54A       | CT563 | SN74A | CT563 | UNIT |
|-----------------|------------------------------------|-------------|-------|-------|-------|------|
|                 |                                    | MIN         | MAX   | MIN   | MAX   | UNIT |
| Vсс             | Supply voltage                     | 4.5         | 5.5   | 4.5   | 5.5   | V    |
| VIH             | High-level input voltage           | 2           | 3     | 2     |       | V    |
| V <sub>IL</sub> | Low-level input voltage            |             | 0.8   |       | 0.8   | V    |
| VI              | Input voltage                      | 0           | Vcc   | 0     | VCC   | V    |
| Vo              | Output voltage                     | 0/          | Vcc   | 0     | VCC   | V    |
| ІОН             | High-level output current          | 2           | -24   |       | -24   | mA   |
| l <sub>OL</sub> | Low-level output current           | 20          | 24    |       | 24    | mA   |
| Δt/Δν           | Input transition rise or fall rate | Q           | 8     |       | 8     | ns/V |
| TA              | Operating free-air temperature     | <b>-</b> 55 | 125   | -40   | 85    | °C   |

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DADAMETED          | TEST SOMBITIONS   |       | T    | A = 25°0 | ;     | SN54A | CT563 | SN74A | CT563 |      |
|--------------------|---|-------|------|----------|-------|-------|-------|-------|-------|------|
| PARAMETER          | TEST CONDITIONS   | vcc   | MIN  | TYP      | MAX   | MIN   | MAX   | MIN   | MAX   | UNIT |
|                    | Jan = 50 uA   | 4.5 V | 4.4  | 4.49     |       | 4.4   |       | 4.4   |       |      |
|                    | I <sub>OH</sub> = -50 μA                                      | 5.5 V | 5.4  | 5.49     |       | 5.4   |       | 5.4   |       |      |
| Vou                | 1011 = 24 mA  | 4.5 V | 3.86 |          |       | 3.7   |       | 3.76  |       | V    |
| VOH                | $I_{OH} = -24 \text{ mA}$                                     | 5.5 V | 4.86 |          |       | 4.7   |       | 4.76  |       | V    |
|                    | $I_{OH} = -50 \text{ mA}^{\dagger}$                           | 5.5 V |      |          |       | 3.85  | 4     |       |       |      |
|                    | $I_{OH} = -75 \text{ mA}^{\dagger}$                           | 5.5 V |      |          |       |       | 7     | 3.85  |       |      |
|                    | I <sub>OL</sub> = 50 μA                                       | 4.5 V |      | 0.001    | 0.1   |       | 0.1   |       | 0.1   | ٧    |
|                    | ΙΟΣ = 30 μΑ   | 5.5 V |      | 0.001    | 0.1   |       | 0.1   |       | 0.1   |      |
| \/a.               | I <sub>OL</sub> = 24 mA                                       | 4.5 V |      |          | 0.36  | 2     | 0.5   |       | 0.44  |      |
| VOL                | IOL = 24 IIIA   | 5.5 V |      |          | 0.36  | 30    | 0.5   |       | 0.44  |      |
|                    | I <sub>OL</sub> = 50 mA <sup>†</sup>                          | 5.5 V |      |          |       | 9     | 1.65  |       |       |      |
|                    | I <sub>OL</sub> = 75 mA <sup>†</sup>                          | 5.5 V |      |          |       |       |       |       | 1.65  |      |
| loz                | $V_O = V_{CC}$ or GND   | 5.5 V |      |          | ±0.25 |       | ±5    |       | ±2.5  | μΑ   |
| lį                 | V <sub>I</sub> = V <sub>CC</sub> or GND                       | 5.5 V |      |          | ±0.1  |       | ±1    |       | ±1    | μΑ   |
| Icc                | $V_I = V_{CC}$ or GND, $I_O = 0$                              | 5.5 V |      |          | 4     |       | 80    |       | 40    | μΑ   |
| ∆l <sub>CC</sub> ‡ | One input at 3.4 V,<br>Other inputs at GND or V <sub>CC</sub> | 5.5 V |      | 0.6      |       |       | 1.6   |       | 1.5   | mA   |
| C <sub>i</sub>     | $V_I = V_{CC}$ or GND   | 5 V   |      | 4.5      |       |       |       |       |       | pF   |

<sup>†</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed 2 ms.

## timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

|                 |                             | T <sub>A</sub> = 2 | 25°C | SN54ACT563 |     | SN74ACT563 |     | UNIT |
|-----------------|-----------------------------|--------------------|------|------------|-----|------------|-----|------|
|                 |                             | MIN                | MAX  | MINO       | MAX | MIN        | MAX | UNII |
| t <sub>W</sub>  | Pulse duration, LE high     | 3                  |      | 5          | 7,  | 3          |     | ns   |
| t <sub>su</sub> | Setup time, data before LE↓ | 4                  |      | 4.5        |     | 4.5        |     | ns   |
| th              | Hold time, data after LE↓   | 0                  |      | 1.5        |     | 0          |     | ns   |



<sup>‡</sup> This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or VCC.

## SN54ACT563, SN74ACT563 OCTAL D-TYPE TRANSPARENT LATCHES WITH 3-STATE OUTPUTS

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# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

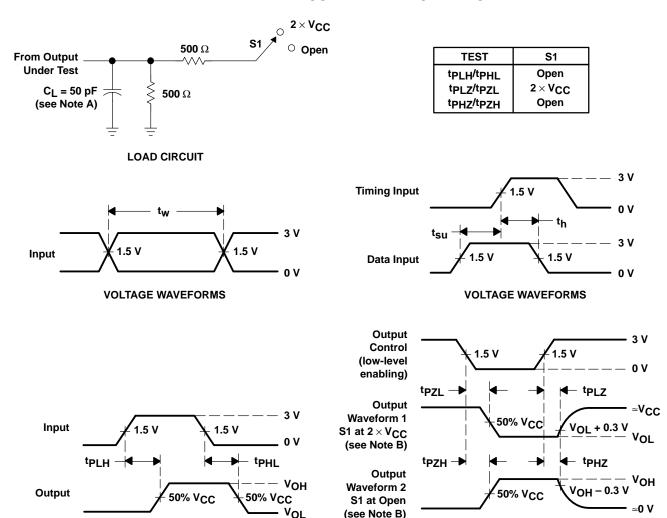
| PARAMETER        | FROM      | то       | TO T <sub>A</sub> = 25°C |     | ;    | SN54A          | CT563 | SN74A | CT563 | UNIT |
|------------------|-----------|----------|--------------------------|-----|------|----------------|-------|-------|-------|------|
| PARAMETER        | (INPUT)   | (OUTPUT) | MIN                      | TYP | MAX  | MIN            | MAX   | MIN   | MAX   | UNIT |
| <sup>t</sup> PLH | D         | Īα       | 3                        | 7   | 11.5 | 1              | 14.5  | 2.5   | 12.5  | ns   |
| <sup>t</sup> PHL | D         | σ        | 3                        | 6   | 10   | 1              | 12    | 2.5   | 11    | 115  |
| <sup>t</sup> PLH | LE        | lα       | 3                        | 6.5 | 10.5 | 1              | 12.5  | 2.5   | 11.5  | ns   |
| <sup>t</sup> PHL | LL        | Q        | 2.5                      | 5.5 | 9.5  | 1,             | 11.5  | 2     | 10.5  | 113  |
| <sup>t</sup> PZH | <u> -</u> | lα       | 2.5                      | 5.5 | 9    | ₽,             | 11.5  | 2     | 10    | 2    |
| <sup>t</sup> PZL | ŌĒ        | α        | 2                        | 5.5 | 8.5  | O <sub>C</sub> | 11    | 2     | 9.5   | ns   |
| <sup>t</sup> PHZ | ŌĒ        | Īα       | 3.5                      | 6.5 | 10.5 | 4 1            | 12    | 2.5   | 11.5  | ns   |
| tPLZ             | OE        | ά        | 2                        | 4.5 | 8    | 1              | 9.5   | 1     | 8.5   | 115  |

## operating characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$

|                 | PARAMETER                     | TEST CO                 | TYP       | UNIT |    |
|-----------------|-------------------------------|-------------------------|-----------|------|----|
| C <sub>pd</sub> | Power dissipation capacitance | C <sub>L</sub> = 50 pF, | f = 1 MHz | 50   | pF |

**VOLTAGE WAVEFORMS** 

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. CL includes probe and jig capacitance.

**VOLTAGE WAVEFORMS** 

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50~\Omega$ ,  $t_f \leq$  2.5 ns,  $t_f \leq$  2.5 ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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#### PACKAGING INFORMATION

| Orderable part number | Status   | Material type | Package   Pins  | Package qty   Carrier | RoHS | Lead finish/  | MSL rating/        | Op temp (°C) | Part marking |
|-----------------------|----------|---------------|-----------------|-----------------------|------|---------------|--------------------|--------------|--------------|
|                       | (1)      | (2)           |                 |                       | (3)  | Ball material | Peak reflow        |              | (6)          |
|                       |          |               |                 |                       |      | (4)           | (5)                |              |              |
| SN74ACT563DW          | Obsolete | Production    | SOIC (DW)   20  | -                     | -    | Call TI       | Call TI            | -40 to 85    | ACT563       |
| SN74ACT563DWR         | Active   | Production    | SOIC (DW)   20  | 2000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | ACT563       |
| SN74ACT563DWR.A       | Active   | Production    | SOIC (DW)   20  | 2000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | ACT563       |
| SN74ACT563N           | Active   | Production    | PDIP (N)   20   | 20   TUBE             | Yes  | NIPDAU        | N/A for Pkg Type   | -40 to 85    | SN74ACT563N  |
| SN74ACT563N.A         | Active   | Production    | PDIP (N)   20   | 20   TUBE             | Yes  | NIPDAU        | N/A for Pkg Type   | -40 to 85    | SN74ACT563N  |
| SN74ACT563PW          | Obsolete | Production    | TSSOP (PW)   20 | -                     | -    | Call TI       | Call TI            | -40 to 85    | AD563        |
| SN74ACT563PWR         | Active   | Production    | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | AD563        |
| SN74ACT563PWR.A       | Active   | Production    | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | AD563        |

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

## **PACKAGE OPTION ADDENDUM**

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## **PACKAGE MATERIALS INFORMATION**

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#### TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device        | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|---------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74ACT563DWR | SOIC            | DW                 | 20 | 2000 | 330.0                    | 24.4                     | 10.8       | 13.3       | 2.7        | 12.0       | 24.0      | Q1               |
| SN74ACT563PWR | TSSOP           | PW                 | 20 | 2000 | 330.0                    | 16.4                     | 6.95       | 7.0        | 1.4        | 8.0        | 16.0      | Q1               |

## **PACKAGE MATERIALS INFORMATION**

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#### \*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74ACT563DWR | SOIC         | DW              | 20   | 2000 | 356.0       | 356.0      | 45.0        |
| SN74ACT563PWR | TSSOP        | PW              | 20   | 2000 | 353.0       | 353.0      | 32.0        |

## **PACKAGE MATERIALS INFORMATION**

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#### **TUBE**



#### \*All dimensions are nominal

| Device        | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|---------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74ACT563N   | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| SN74ACT563N.A | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |

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